

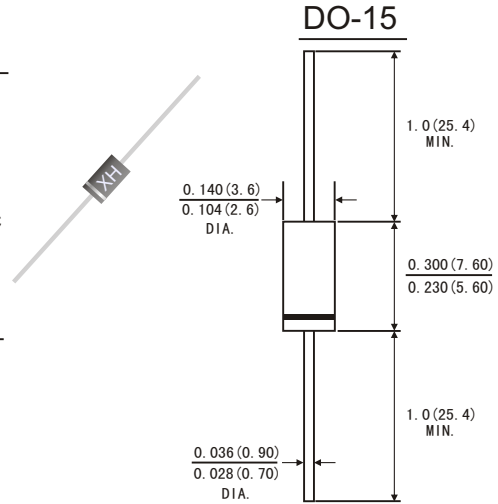


FEATURES

- Low forward voltage drop
- High current capability
- High reliability
- High surge current capability
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- High temperature soldering guaranteed: 260°C/10 seconds at terminals

MECHANICAL DATA

- Case: JEDEC DO-15 molded plastic body
- TerMInAls: Plated axial leads, solderable per MIL-STD-750, method 2026
- Polarity: color band denotes cathode end
- Mounting Position: Any
- Weight: 0.014 ounce, 0.39 gram



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating at 25°C ambient temperature unless otherwise specified, Single phase, half wave, 60HZ, resistive or inductive load. For capacitive load, derate current by 20%.)

	Symbols	SF 21	SF 22	SF 23	SF 24	SF 25	SF 26	SF 27	SF 28	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	500	600	Volts
Maximum RMS Voltage	V_{RMS}	35	70	105	140	210	280	350	420	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	500	600	Volts
Maximum Average Forward Rectified Current 0.375" (9.5mm) Lead Length @ $T_A=55^\circ\text{C}$	$I_{(AV)}$	2.0								Amps
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	50								Amps
Maximum Instantaneous Forward Voltage at 2.0 A	V_F	0.95			1.3			1.7		Volts
Maximum DC Reverse Current At Rated DC Blocking Voltage	$T_A=25^\circ\text{C}$	5.0								μA
	$T_A=100^\circ\text{C}$									
Maximum Reverse Recovery Time (Note 1)	T_{RR}	35								ns
Typical Junction Capacitance (Note 2)	C_j	40				30				pF
Typical Thermal Resistance (NOTE 3)	$R_{\theta JA}$	65								$^\circ\text{C}/\text{W}$
Operating Temperature Range	T_j	-65 to +125								$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to +150								$^\circ\text{C}$

Note: 1. Reverse Recovery Test conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{RR}=0.25\text{A}$.

2. Measured at 1MHz and applied reverse voltage of 4.0 Volts.

3. Mount on Cu-Pad Size 10mmX10mm on PCB.



FIG.1-MAXIMUM AVERAGE FORWARD CURRENT DERATING

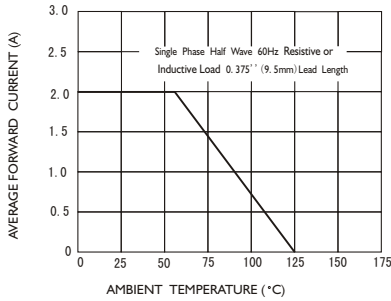


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

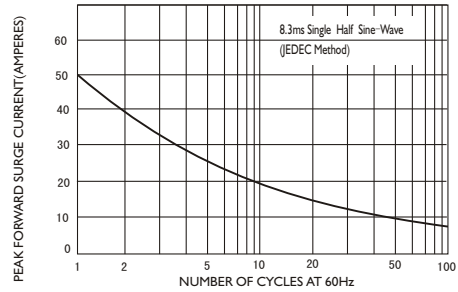


FIG.3-TYPICAL FORWARD CHARACTERISTICS

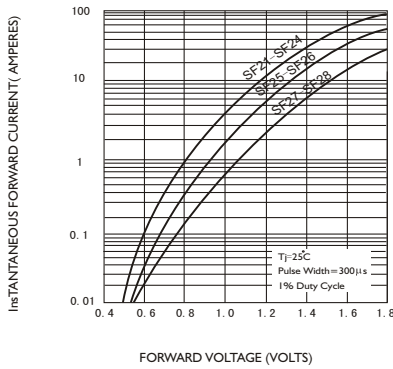


FIG.4-TYPICAL REVERSE CHARACTERISTICS

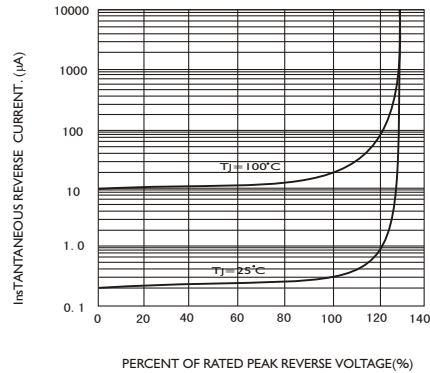


FIG.5-TYPICAL JUNCTION CAPACITANCE

